



FEATURES

- High linearity
- Bandwidth 10 GHz, 20 GHz, 40 GHz
- High stability
- Low insertion loss
- Operation in C and L bands

APPLICATIONS

- RoF
- Antenna remoting
- Microwave and Radar links
- Space and defence systems

OPTIONS

- 1300 nm, 1000 nm, 800 nm versions
- Hermetic sealing
- Space qualified

RELATED EQUIPMENTS

- DR-AN RF amplifiers
- MBC ditherless Bias Controllers
- Turn-key ModBox systems

The MXAN-LN series are high bandwidth intensity modulators specially designed for the transmission of analog signals over optical fibers.

The MXAN-LN's performance parameters meet the requirement of the most demanding analog transmission links for military and civil applications: the x-cut design offers an unmatched stability, the low insertion loss optimizes links gain and the high linearity preserves the signal quality. They are specially suitable for microwave links and remoted antennas.

MXAN-LN-10 Performance Highlights

Parameter	Min	Typ	Max	Unit
Operating wavelength	1530	-	1625	nm
Insertion loss	-	3.5	-	dB
Insertion loss (with low IL option)	-	2.7	3	dB
Electro-optical bandwidth	10	12	-	GHz
V_{π} RF @ 50 kHz	-	5.5	-	V

Specifications given at 25 °C, 50 Ω , 1550 nm

MXAN-LN-20 Performance Highlights

Parameter	Min	Typ	Max	Unit
Operating wavelength	1530	-	1625	nm
Insertion loss	-	3.5	-	dB
Electro-optical bandwidth	20	25	-	GHz
V_{π} RF @ 50 kHz	-	5	-	V
2 nd harmonic suppression ratio	-	60	-	dB

Specifications given at 25 °C, 50 Ω , 1550 nm

MXAN-LN-40 Performance Highlights

Parameter	Min	Typ	Max	Unit
Operating wavelength	1530	-	1625	nm
Insertion loss	-	3.5	-	dB
Electro-optical bandwidth	28	30	-	GHz
V_{π} RF @ 50 kHz	-	5	-	V
2 nd harmonic suppression ratio	-	60	-	dB

Specifications given at 25 °C, 50 Ω , 1550 nm

MXAN-LN-10

10 GHz Analog Intensity Modulator

Electrical Characteristics

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Electro-optic bandwidth	S_{21}	RF electrodes, from 2 GHz	10	12	-	GHz
Ripple S_{21}	ΔS_{21}	RF electrodes, $f < 10$ GHz	-	0.5	1	dB
Electrical return loss	S_{11}	RF electrodes, $f < 10$ GHz	-	-12	-10	dB
V_{π} RF @50 kHz	$V_{\pi RF_{50\text{ kHz}}}$	RF electrodes	-	5.5	6	V
V_{π} RF @10 GHz	$V_{\pi RF_{10\text{ GHz}}}$	RF electrodes	-	6.5	7	V
V_p DC electrodes	$V_{\pi DC}$	DC electrodes	-	6.5	7	V
2 nd harmonic suppression ratio	$H_1 - H_2$	Measured @5 GHz	-	70	-	dB
Input 3 rd order intercept	IIP3	Measured @5 GHz	28	30	-	dBm
RF input impedance	Z_{in-RF}	-	-	50	-	Ω
DC input impedance	Z_{in-DC}	-	-	1	-	M Ω

50 Ω RF input

Optical Characteristics

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Crystal	-	-	Lithium Niobate X-Cut Y-Prop			
Operating wavelength	λ	-	1530	1550	1625	nm
Insertion loss	IL	Without connectors	-	3.5	-	dB
Insertion loss (with low IL option)	LIL	Without connectors	-	2.7	3	dB
DC extinction ratio	ER	Measured with narrow source linewidth < 200 MHz	20	22	-	dB
Optical return loss	ORL	-	-40	-45	-	dB
Chirp	α	-	-0.1	0	0.1	-

All specifications given at 25°C, 1550 nm, unless differently specified

Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect device reliability.

Parameter	Symbol	Min	Max	Unit
RF input power	EP_{in}	-	28	dBm
Bias voltage	V_{bias}	-20	+20	V
Optical input power	OP_{in}	-	20	dBm
Operating temperature	OT	0	+70	°C
Storage temperature	ST	-40	+85	°C

MXAN-LN-20

20 GHz Analog Intensity Modulator

Electrical Characteristics

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Electro-optic bandwidth	S_{21}	RF electrodes, from 2 GHz	20	25	-	GHz
Ripple S_{21}	ΔS_{21}	RF electrodes, $f < 20$ GHz	-	0.5	1	dB
Electrical return loss	S_{11}	RF electrodes, $f < 20$ GHz	-	-12	-10	dB
V_{π} RF @50 kHz	$V_{\pi RF_{50\text{ kHz}}}$	RF electrodes	-	5	5.5	V
V_{π} RF @20 GHz	$V_{\pi RF_{20\text{ GHz}}}$	RF electrodes	-	7	8	V
V_{π} DC electrodes	$V_{\pi DC}$	DC electrodes	-	6.5	7	V
2 nd harmonic suppression ratio	$H_1 - H_2$	Measured @5 GHz, $RF_{IN} = 0$ dBm	-	60	-	dB
Input 3 rd order intercept	IIP3	Measured @5 GHz	28	30	-	dBm
RF input impedance	Z_{in-RF}	-	-	50	-	Ω
DC input impedance	Z_{in-DC}	-	-	1	-	M Ω

50 Ω RF input

Optical Characteristics

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Crystal	-	-	Lithium Niobate X-Cut Y-Prop			
Operating wavelength	λ	-	1530	1550	1625	nm
Insertion loss	IL	Without connectors	-	3.5	4.5	dB
DC extinction ratio	ER	Measured with narrow source linewidth < 200 MHz	20	25	-	dB
Optical return loss	ORL	-	-40	-45	-	dB
Chirp	α	-	-0.1	0	0.1	-

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Parameter	Symbol	Min	Max	Unit
RF input power	EP_{in}	-	28	dBm
Bias voltage	V_{bias}	-20	+20	V
Optical input power	OP_{in}	-	20	dBm
Operating temperature	OT	0	+70	°C
Storage temperature	ST	-40	+85	°C

MXAN-LN-40

40 GHz Analog Intensity Modulator

Electrical Characteristics

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Electro-optic bandwidth	S_{21}	RF electrodes, from 2 GHz	28	30	-	GHz
Ripple S_{21}	ΔS_{21}	RF electrodes, $f < 30$ GHz	-	0.5	1	dB
Electrical return loss	S_{11}	RF electrodes, $f < 30$ GHz	-	-12	-10	dB
$V\pi$ RF @50 kHz	$V\pi RF_{50\text{ kHz}}$	RF electrodes	-	5	6	V
$V\pi$ RF @20 GHz	$V\pi RF_{20\text{ GHz}}$	RF electrodes	-	7	8	V
$V\pi$ DC electrodes	$V\pi DC$	DC electrodes	-	6.5	7	V
2 nd harmonic suppression ratio	$H_1 - H_2$	Measured @5 GHz, $RF_{IN} = 0$ dBm	-	60	-	dB
Input 3 rd order intercept	IIP3	Measured @5 GHz	28	30	-	dBm
RF input impedance	Z_{in-RF}	-	-	50	-	Ω
DC input impedance	Z_{in-DC}	-	-	1	-	M Ω

50 Ω RF input

Optical Characteristics

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Crystal	-	-	Lithium Niobate X-Cut Y-Prop			
Operating wavelength	λ	-	1530	1550	1625	nm
Insertion loss	IL	Without connectors	-	3.5	4.5	dB
DC extinction ratio	ER	Measured with narrow source linewidth < 200 MHz	20	25	-	dB
Optical return loss	ORL	-	-40	-45	-	dB
Chirp	α	-	-0.1	0	0.1	-

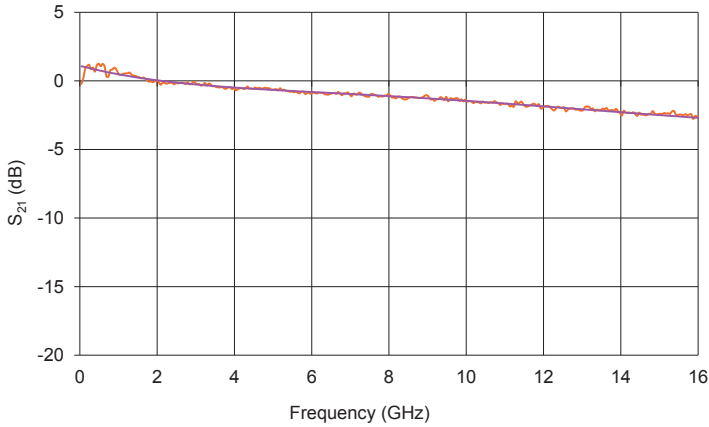
All specifications given at 25°C, 1550 nm, unless differently specified

Absolute Maximum Ratings

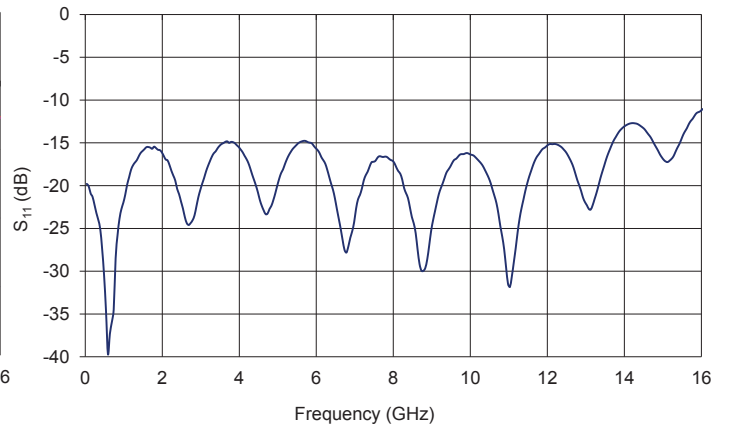
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Parameter	Symbol	Min	Max	Unit
RF input power	EP_{in}	-	28	dBm
Bias voltage	V_{bias}	-20	+20	V
Optical input power	OP_{in}	-	20	dBm
Operating temperature	OT	0	+70	°C
Storage temperature	ST	-40	+85	°C

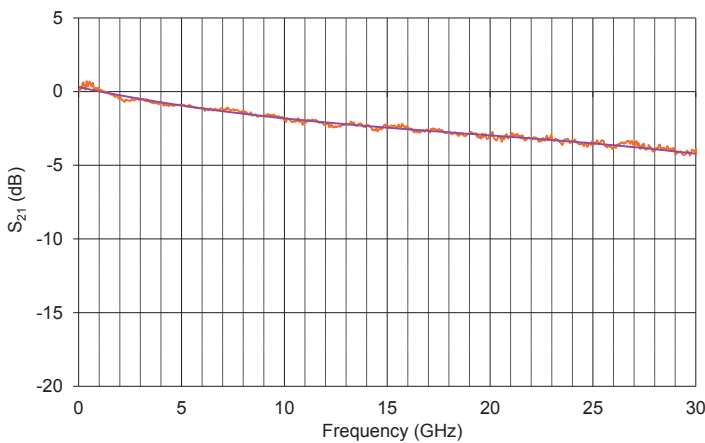
MXAN-LN-10 Typical S_{21} Curve



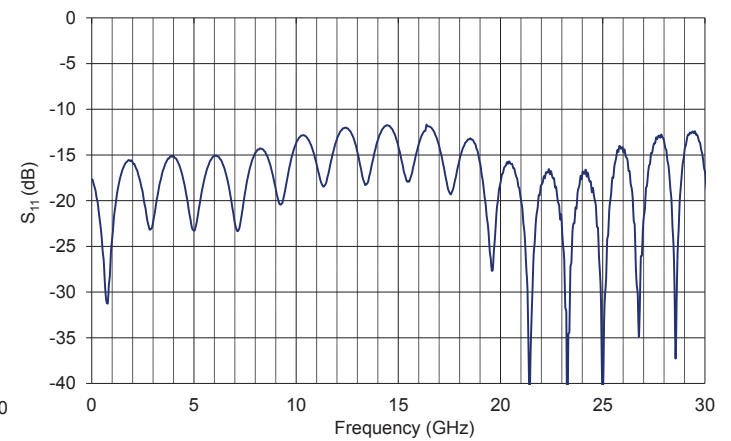
MXAN-LN-10 Typical S_{11} Curve



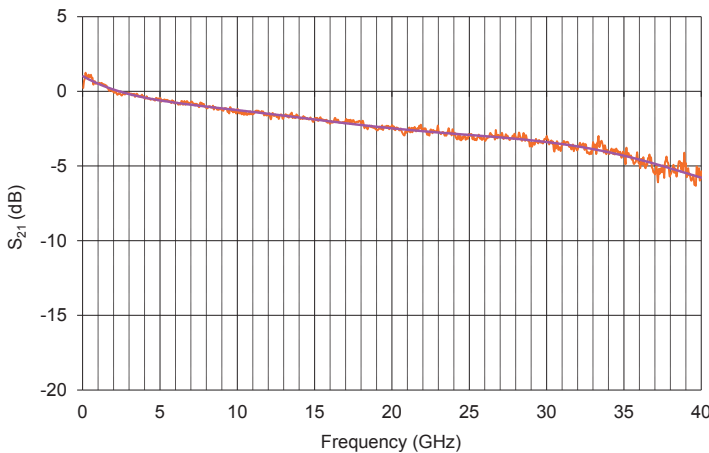
MXAN-LN-20 Typical S_{21} Curve



MXAN-LN-20 Typical S_{11} Curve



MXAN-LN-40 Typical S_{21} Curve



MXAN-LN-40 Typical S_{11} Curve

